Contact Name Title - Contact Product-Env-Stewards Authorized Representative* Product-Env-Stewards Product	ASSOCIATION CONNECTIN	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
Company name* Company name* Company unique ID Unique ID Authority Response Date* 2024-05-16 Contact Name Title - Contact Title - Contact Phone - Contact* Phone - Contact* Product-Env-Stewards Product-Env-Stewar	752-21.1										als and Mfg	Informati	on		
Semil	upplier Inforn														
Title - Contact Name Product Envis Compliance NA Product Envis Email - Contact* Product-Env-Stewards Pr	Company name* Company unique ID					Ţ	Unique ID Authority				Response Date*				
Product-Env-Stewards	nsemi											2024-05-1	6		
Authorized Representative* Product-Env-Stewards Product Enviro Compliance Requester Item Number Requester Item	ontact Name			Title - Conta	ct		1	Phone - Contac	et*			Email - C	ontact*		
Product Envi-Stewards Requester Item Number Mfr Item Number Manufacturing Site Mfr Item Number Mgr Item Number of Reflow Cycles Mgr Item Number of Reflow	Product-Env-Stewa	ards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM NCV8664ST50T3G ANA ULTRA LOW IQ LDO 2024-05-16 MY1 109.99 mg I Manufacturing Proccess Information Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Seconds Seco	uthorized Represe	entative*	Title - Representative			I	Phone - Representative*				Email - Representative*				
Manufacturing Proccess Information Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Matte Tin (Sn) - annealed CU Alloy 3 Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles 260 C 30 seconds 3	Product-Env-Stewards Pr			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Manufacturing Proccess Information Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Matte Tin (Sn) - annealed CU Alloy 3 260 C 30 seconds 3	Requesto	er Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	Version Manufacturing Site		W	eight*	UOM	Unit Type
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Matte Tin (Sn) - annealed CU Alloy 3 260 C 30 seconds 3			NCV8664	4ST50T3G	ANA ULTRA LOV	W IQ LDO		2024-05-16		N	ЛY1	10	9.99	mg	Each
Matte Tin (Sn) - annealed CU Alloy 3 260 C 30 seconds 3 omments					A11	CTD 020 MCI	Datina	De els Dese	De de T		Man Time at Peak	T	. Name	F. F. Flance	1
Comments					Alloy J-S	STD-020 MSL	_ Rating		ess Body T	Τ'				er of Reflow Cyc	les
	•	n (Sn) - annealed	C	U Alloy	[3			260		IC	30	second	3 3		
1 LEN 1 LUN; MISL 3 KAUCO HEM FEQUIFES DAKE AND DTY PACK (AHEF CICCUTCAL LEST)		. 2 D-4-1 '4 ' T)-l J D	D1- (- 6											
or more information regarding material composition please refer to page 3		•													

RoHS Material Composition Declaration			Declaration Type *	Detail	led
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an		
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the company that the company tha	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit ide in you believe may apply. If the part is an assembly is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the this and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.3	mg	Supplier	Silicon (Si)	7440-21-3		3.3	mg
Die Attach	2.37	mg	Supplier	Silver (Ag)	7440-22-4		1.7775	mg
			Supplier	Epoxy resins	129915-35-1		0.5925	mg
Lead Frame	37.17	mg	Supplier	Silver (Ag)	7440-22-4		0.4832	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0372	mg
			Supplier	Iron (Fe)	7439-89-6		0.8921	mg
			Supplier	Copper (Cu)	7440-50-8		35.7575	mg
Mold Compound-Black	59.7	mg		Epoxy Phenol Resin	proprietary data		5.373	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2985	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		52.2076	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.8209	mg
Plating	7.44	mg	Supplier	Tin (Sn)	7440-31-5		7.44	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg